





Description:

Epitaxial medium-speed switching diode with a low leakage current in a small SOT-23 plastic SMD package.

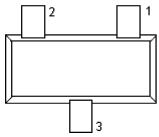
Features:

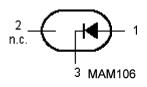
- Plastic SMD package
- Low leakage current: typical 3pA
- Switching time: typical 0.8µs
- · Continuous reverse voltage: maximum 75V
- · Repetitive peak reverse voltage: maximum 85V
- Repetitive peak forward current: maximum 500mA

Application:

Low leakage current applications in surface mounted circuits.

Simplified Outline (SOT-23) and Symbol





Top view

Pin	Description	
1	Anode	
2	Not Connected	
3	Cathode	

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Limiting Values

In accordance with the Absolute Maximum Rating System (IEC 134).

Symbol	Parameter	Conditions	Min.	Max.	Unit	
V_{RRM}	Repetitive Peak Reverse Voltage	-	-	85	V	
V_R	Continuous Reverse Voltage	-	- 75		v	
I _F	Continuous Forward Current	Note 1	-	215	mA	
I _{FRM}	Repetitive Peak Forward Current	-	-	500		
I _{FSM}	Non-repetitive Peak Forward Current	Square Wave, T_j = 25°C Prior to Surge t_p = 1 μ s t_p = 1 μ s t_p = 1s	-	4 1 0.5	A A A	
P _{tot}	Total Power Dissipation	-T _a = 25°C, Note 1	-65	250	mW	
T _{stg}	Storage Temperature	-	-	+150	°C	
T _j	Junction Temperature	-	-	150		

Note: 1. Device mounted on a FR4 printed-circuit board.

Electrical Characteristics ($T_j = 25$ °C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Max.	Unit
V _F	Forward Voltage	I _F = 1mA I _F = 10mA I _F = 50mA I _F = 150mA	- - -	0.9 1 1.1 1.25	V V V
I _R	Reverse Current	V _R = 75V V _R = 75V; T _j = 150°C	0.003 3	5 80	nA nA
C _d	Diode Capacitance	f = 1MHz, V _R = 0	3	-	pF
t _{rr}	Reverse Recovery Time	When Switched from $I_F = 10 \text{mA}$ to $I_R = 10 \text{mA}$; $R_L = 100 \Omega$; Measured at $I_R = 1 \text{mA}$	0.8	3	μѕ

Thermal Characteristics

Symbol	Parameter	Conditions	Value	Unit	
R _{th j-tp}	Thermal Resistance from Junction to Tie-Point	-	330	IZ // A /	
R _{th j-a}	Thermal Resistance from Junction to Ambient	Note 1	500	K/W	

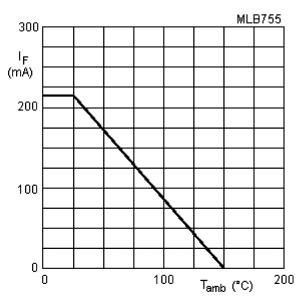
Note: 1. Device mounted on a FR4 printed-circuit board.





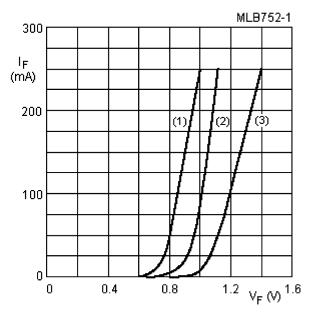
Graphical Data

Maximum Permissible Continuous Forward Current as a Function of Ambient Temperature



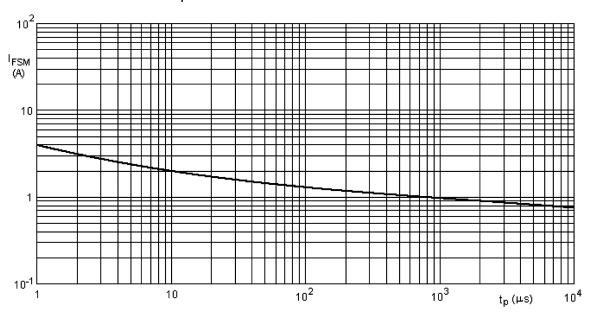
Device Mounted on a FR4 Printed-Circuit Board.

Forward Current as a Function of Forward Voltage



- (1) T_i = 150°C; Typical values.
- (2) $T_i = 25$ °C; Typical values.
- (3) $T_i = 25$ °C; maximum values.

Maximum Permissible Non-Repetitive Peak Forward Current as a Function of Pulse Duration



Based on square wave currents; $T_i = 25^{\circ}C$ prior to surge.

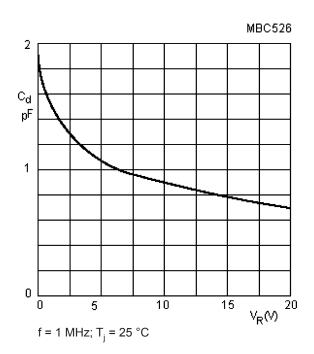
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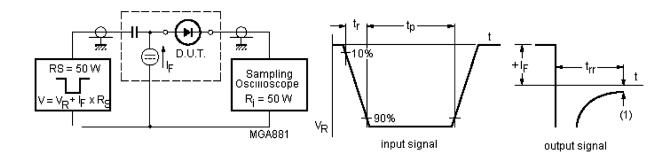


Reverse Current as a Function of Junction Temperature

Diode Capacitance as a Function of Reverse Voltage; Typical Values



Reverse Recovery Time Test Circuit and Waveforms



Part Number Table

Description	Part Number		
Diode, High Speed, SOT-23	BAS116+		

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